Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

PREMINDERS

Product information in this catalog is as of October 2014. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that TAIYO YUDEN CO., LTD. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact TAIYO YUDEN CO., LTD. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact TAIYO YUDEN CO., LTD. for more detail in advance.

Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").
 - It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that TAIYO YUDEN CO., LTD. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. TAIYO YUDEN CO., LTD. grants no license for such rights.
- Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

MULTILAYER CHIP INDUCTORS(CK SERIES / CK SERIES S TYPE)





■PARTS NUMBER

*Operating Temp. : -40~+85°C

△=Blank space



(1)S	eries	name

Code	Series name					
CK△	Multilayer ship industry					
CKS	Multilayer chip inductor					

②Dimensions (L × W)

Code	Type (inch)	Dimensions (L×W) [mm]
1608	1608 (0603)	1.6 × 0.8
2125	2125(0805)	2.0 × 1.25

3 Nominal inductance

<u> </u>							
Code (example)	Nominal inductance[μ H]						
1R0	1.0						
100	10						

4 Inductance tolerance

Our reduction color unico						
Code	Inductance tolerance					
М	±20%					

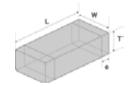
5Packaging

©:						
Code	Packaging					
-т	Taping					

6 Internal code

O	
Code	Internal code
Δ	Standard

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Tomas		w	_		Standard quantity [pcs]		
Туре		VV	'	е	Paper tape	Embossed tape	
CK 1608	1.6±0.15	0.8±0.15	0.8±0.15	0.3±0.2	4000		
(0603)	(0.063±0.006)	(0.031 ± 0.006)	(0.031 ± 0.006)	(0.012 ± 0.008)	4000	_	
CK 2125 CKS2125 (0805)	2.0+0.3/-0.1	1.25±0.2	0.85 ± 0.2	0.5±0.3	4000		
	(0.079+0.012/-0.004)	(0.049 ± 0.008)	(0.033 ± 0.008)	(0.020 ± 0.012)	4000	_	
	2.0+0.3/-0.1	1.25±0.2	1.25±0.2	0.5±0.3	_	2000	
(0000)	$(0.079 \pm 0.012 / -0.004)$	(0.049 ± 0.008)	(0.049 ± 0.008)	(0.020 ± 0.012)	_	2000	

Unit:mm(inch)

■PARTS NUMBER

CK1608

Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]	Thickness [mm]
CK 1608 4R7M-T	RoHS	4.7	±20%	25	0.45	60	4	0.80 ±0.15
CK 1608 100M-T	RoHS	10.0	±20%	17	0.85	50	2	0.80 ± 0.15

CK2125

Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency	DC Resistance[Ω]		Rated current [mA] (max.)	Measuring frequency	Thickness
		27-13		[MHz] (min.)	(max.)	(typ.)	2	[MHz]	
CK 2125 R10M-T	RoHS	0.10	±20%	235	0.16	0.08	500	25	0.85 ±0.2
CK 2125 R15M-T	RoHS	0.15	±20%	200	0.20	0.13	500	25	0.85 ±0.2
CK 2125 R22M-T	RoHS	0.22	±20%	170	0.23	0.16	400	25	0.85 ± 0.2
CK 2125 R33M-T	RoHS	0.33	±20%	145	0.28	0.21	400	25	0.85 ±0.2
CK 2125 R47M-T	RoHS	0.47	±20%	125	0.32	0.25	400	25	1.25 ±0.2
CK 2125 R68M-T	RoHS	0.68	±20%	105	0.45	0.35	300	25	1.25 ±0.2
CK 2125 1R0M-T	RoHS	1.0	±20%	75	0.26	0.19	220	10	0.85 ± 0.2
CK 2125 1R5M-T	RoHS	1.5	±20%	60	0.28	0.23	170	10	0.85 ±0.2
CK 2125 2R2M-T	RoHS	2.2	±20%	50	0.35	0.26	150	10	0.85 ±0.2
CK 2125 3R3M-T	RoHS	3.3	±20%	41	0.43	0.38	130	10	1.25 ±0.2
CK 2125 4R7M-T	RoHS	4.7	±20%	35	0.48	0.44	120	10	1.25 ±0.2
CK 2125 6R8M-T	RoHS	6.8	±20%	29	0.52	0.39	70	4	1.25 ±0.2
CK 2125 100M-T	R₀HS	10.0	±20%	24	0.65	0.55	60	2	1.25 ±0.2

CKS2125

Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance[Ω]		Rated current [mA] (max.)	Measuring frequency	Thickness [mm]
					(max.)	(typ.)	[III/] (IIIax./	[MHz]	Lilling
CKS2125 1R0M-T	R₀HS	1.0	±20%	75	0.12	0.09	280	10	0.85 ±0.2
CKS2125 2R2M-T	RoHS	2.2	±20%	50	0.19	0.15	170	10	0.85 ±0.2
CKS2125 4R7M-T	RoHS	4.7	±20%	35	0.30	0.25	130	10	1.25 ±0.2
CKS2125 100M-T	RoHS	10.0	±20%	24	0.52	0.40	110	2	1.25 ±0.2

[▶] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

Multilayer chip inductors Multilayer chip inductors for high frequency, Multilayer chip bead inductors Multilayer common mode choke coils (MC series F type)

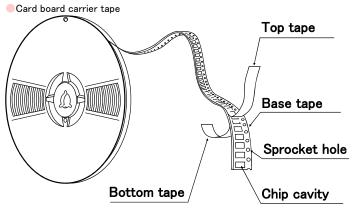
■PACKAGING

1 Minimum Quantity

Tape & Reel Packaging								
Turno	Thickness	Standard Q	uantity [pcs]					
Туре	mm(inch)	Paper Tape	Embossed Tape					
CK1608(0603)	0.8 (0.031)	4000	_					
OK010E (000E)	0.85(0.033)	4000	_					
CK2125 (0805)	1.25(0.049)	_	2000					
OKC010E (000E)	0.85(0.033)	4000	_					
CKS2125 (0805)	1.25(0.049)	_	2000					
CKP1608(0603)	0.8 (0.031)	4000	_					
CKP2012 (0805)	0.9 (0.035)	_	3000					
CKP2016 (0806)	0.9 (0.035)	_	3000					
	0.7 (0.028)	_	3000					
CKP2520(1008)	0.9 (0.035)	_	3000					
	1.1 (0.043)	_	2000					
NM2012 (0805)	0.9 (0.035)	_	3000					
NIMOTOO (4000)	0.9 (0.035)	_	3000					
NM2520(1008)	1.1 (0.043)	_	2000					
LK1005(0402)	0.5 (0.020)	10000	_					
LK1608(0603)	0.8 (0.031)	4000	_					
	0.85(0.033)	4000	_					
LK2125 (0805)	1.25(0.049)	_	2000					
HK0402 (01005)	0.2 (0.008)	20000	_					
HK0603(0201)	0.3 (0.012)	15000	_					
HK1005(0402)	0.5 (0.020)	10000	_					
HK1608(0603)	0.8 (0.031)	4000	_					
	0.85(0.033)	_	4000					
HK2125 (0805)	1.0 (0.039)	_	3000					
HKQ0402(01005)	0.2 (0.008)	20000	40000					
HKQ0603W(0201)	0.3 (0.012)	15000	_					
HKQ0603C(0201)	0.3 (0.012)	15000	_					
HKQ0603S(0201)	0.3 (0.012)	15000	_					
HKQ0603U(0201)	0.3 (0.012)	15000	_					
AQ105(0402)	0.5 (0.020)	10000	_					
BK0402(01005)	0.2 (0.008)	20000	_					
BK0603(0201)	0.3 (0.012)	15000	_					
BK1005(0402)	0.5 (0.020)	10000	_					
BKH0603(0201)	0.3 (0.012)	15000	_					
BKH1005(0402)	0.5 (0.020)	10000	_					
BK1608(0603)	0.8 (0.031)	4000	_					
DI(0105 (0005)	0.85(0.033)	4000	_					
BK2125(0805)	1.25(0.049)	_	2000					
BK2010(0804)	0.45 (0.018)	4000	_					
BK3216(1206)	0.8 (0.031)	_	4000					
BKP0402 (01005)	0.2 (0.008)	20000	_					
BKP0603(0201)	0.3 (0.012)	15000	_					
BKP1005(0402)	0.5 (0.020)	10000	_					
BKP1608 (0603)	0.8 (0.031)	4000	_					
BKP2125(0805)	0.85 (0.033)	4000	_					
MCF0605(0202)	0.3 (0.012)	15000	_					
MCF0806(0302)	0.4 (0.016)	_	10000					
MCF1210(0504)	0.55 (0.022)	_	5000					
MCF2010(0804)	0.45 (0.018)	_	4000					
,		+	+					

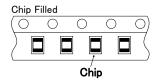
This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

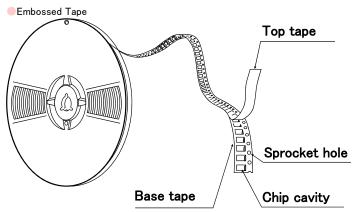
②Taping material



CK	1608
CKP	1608
CK	2125
CKS	2125
LK	1005
LK	1608
LK	2125
HK	0402
HK	0603
HK	1005
HK	1608
HKQ	0402
HKQ	0603
AQ	105

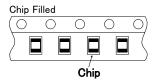
BK	0402
BK	0603
BK	1005
BK	1608
BK	2125
BK	2010
BKP	0402
BKP	0603
BKP	1005
BKP	1608
BKP	2125
BKH	0603
BKH	1005
MCF	0605





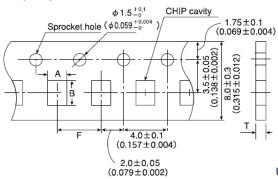
CK	2125
CKS	2125
CKP	2012
CKP	2016
CKP	2520
NM	2012
NM	2520
LK	2125
HKQ	0402
HK	2125

BK	2125	
BK	3216	
MCF	0806	
MCF	1210	
MCF	2010	



3 Taping Dimensions

Paper tape (8mm wide)



Unit: mm (inch)

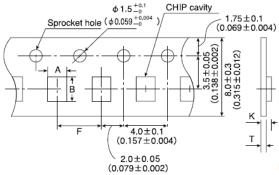
This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

	Thickness	Chip	cavity	Insertion Pitch	Tape Thickness
Туре	mm (inch)	A	В	F	Т
		1.0±0.2	1.8±0.2	4.0±0.1	1.1max
CK1608 (0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
01/0105/0005)	0.05 (0.000)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
CK2125(0805)	0.85 (0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
01(00105(0005)	0.05 (0.000)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
CKS2125(0805)	0.85 (0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
01(D4000(0000)	0.0 (0.004)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
CKP1608(0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
11(1005(0100)	0.5 (0.000)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
LK1005 (0402)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
11(1000(0000)	0.0 (0.004)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
LK1608 (0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
11(0105(0005)	0.05 (0.000)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
LK2125 (0805)	0.85 (0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
111(0,100 (0,100E)	0.0 (0.000)	0.25±0.04	0.45±0.04	2.0±0.05	0.36max
HK0402 (01005)	0.2 (0.008)	(0.010 ± 0.002)	(0.018 ± 0.002)	(0.079 ± 0.002)	(0.014max)
(0000 (0001)	0.0 (0.040)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HK0603(0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
LIK100E (0400)	0.5 (0.000)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
HK1005 (0402)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
LIK1600 (0000)	0.0 (0.001)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
HK1608(0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
LUCO 400 (0100E)	0.0 (0.000)	0.25±0.04	0.45±0.04	2.0±0.05	0.36max
HKQ0402(01005)	0.2 (0.008)	(0.010 ± 0.002)	(0.018 ± 0.002)	(0.079 ± 0.002)	(0.014max)
LIKO0000W(0001)	0.0 (0.010)	0.40 ± 0.06	0.70±0.06	2.0±0.05	0.45max
HKQ0603W(0201)	0.3 (0.012)	(0.016±0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
LIKO00000 (0001)	0.0 (0.010)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ0603C(0201)	0.3 (0.012)	(0.016±0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
LIKO00000 (0001)	0.0 (0.010)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ0603S(0201)	0.3 (0.012)	(0.016±0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
11/(0000011/0001)	0.3 (0.012)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ0603U(0201)		(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
AO105 (0402)	0.5 (0.020) 0.2 (0.008)	0.75±0.1	1.15±0.1	2.0±0.05	0.8max
AQ105(0402)		(0.030 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
BK0402(01005)		0.25±0.04	0.45±0.04	2.0±0.05	0.36max
BR0402 (01003)	0.2 (0.006)	(0.010 ± 0.002)	(0.018 ± 0.002)	(0.079 ± 0.002)	(0.014max)
BK0603(0201)	0.3 (0.012)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
BK0003 (0201)	0.0 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
BK1005(0402)	0.5 (0.020)	0.65 ± 0.1	1.15±0.1	2.0±0.05	0.8max
DI(1000(0402)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079±0.002)	(0.031max)
BK1608(0603)	0.8 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
	0.0 (0.001)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
BK2125(0805)	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
	0.00 (0.000)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157±0.004)	(0.043max)
BK2010(0804)	0.45 (0.018)	1.2±0.1	2.17±0.1	4.0±0.1	0.8max
	5.10 (0.010)	(0.047 ± 0.004)	(0.085 ± 0.004)	(0.157±0.004)	(0.031max)
BKP0402 (01005)	0.2 (0.008)	0.25±0.04	0.45±0.04	2.0±0.05	0.36max
	(5.550)	(0.010 ± 0.002)	(0.018±0.002)	(0.079±0.002)	(0.014max)
BKP0603 (0201)	0.3 (0.012)	0.40 ± 0.06	0.70±0.06	2.0±0.05	0.45max
	,,	(0.016±0.002)	(0.028±0.002)	(0.079±0.002)	(0.018max)
BKP1005 (0402)	0.5 (0.020)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
· ·		(0.026±0.004)	(0.045±0.004)	(0.079±0.002)	(0.031max)
BKP1608 (0603)	0.8 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
		(0.039±0.008)	(0.071 ± 0.008)	(0.157±0.004)	(0.043max)
BKP2125 (0805)	0.85(0.033)	1.5 ± 0.2	2.3 ± 0.2	4.0±0.1	1.1max
·		(0.059±0.008)	(0.091 ± 0.008)	(0.157±0.004)	(0.043max)
BKH0603(0201)	0.3 (0.012)	0.40 ± 0.06	0.70±0.06	2.0±0.05	0.45max
		(0.016±0.002)	(0.028±0.002)	(0.079±0.002)	(0.018max)
BKH1005(0402)	0.5 (0.020)	0.65±0.1	1.15±0.1	2.0 ± 0.05	0.8max
		(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
MCF0605(0202)	0.3 (0.012)	0.62 ± 0.03	0.77 ± 0.03	2.0±0.05	0.45max
		(0.024±0.001)	(0.030 ± 0.001)	(0.079 ± 0.002)	(0.018max)

Unit: mm(inch)

[►] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

Embossed Tape (8mm wide)

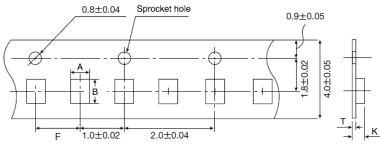


Unit: mm (inch)

Turna	Thickness	Chip	cavity	Insertion Pitch	Tape Th	nickness
Туре	mm(inch)	Α	В	F	K	Т
CK2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
CKS2125 (0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
CKP2012 (0805)	0.9 (0.035)	1.55±0.2 (0.061±0.008)	2.3 ± 0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.3 (0.012)
CKP2016 (0806)	0.9 (0.035)	1.8±0.1 (0.071±0.004)	2.2±0.1 (0.087±0.004)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.25
	0.7 (0.028)		,		1.4 (0.055)	, , ,
CKP2520(1008)	0.9 (0.035)	2.3±0.1 (0.091±0.004)	2.8±0.1 (0.110±0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)
	1.1 (0.043)		(5.110 _ 5.55 1)	,	1.7 (0.067)	
NM2012 (0805)	0.9 (0.035)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.3 (0.012)
NUASTO (4000)	0.9 (0.035)	2.3±0.1	2.8±0.1	4.0±0.1	1.4 (0.055)	0.3
NM2520(1008)	1.1 (0.043)	(0.091 ± 0.004)	(0.110±0.004)	(0.157 ± 0.004)	1.7 (0.067)	(0.012)
LK2125 (0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
(2.1.0.5 (2.2.0.5))	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.5 (0.059)	0.3
HK2125 (0805)	1.0 (0.039)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	2.0 (0.079)	(0.012)
BK2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
BK3216(1206)	0.8(0.031)	1.9±0.1 (0.075±0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)
MCF0806(0302)	0.4 (0.016)	0.75±0.05 (0.030±0.002)	0.95±0.05 (0.037±0.002)	2.0±0.05 (0.079±0.002)	0.55 (0.022)	0.3 (0.012)
MCF1210(0504)	0.55(0.022)	1.15±0.05 (0.045±0.002)	1.40 ± 0.05 (0.055 \pm 0.002)	4.0±0.1 (0.157±0.004)	0.65 (0.026)	0.3 (0.012)
MCF2010(0804)	0.45 (0.018)	1.1±0.1 (0.043±0.004)	2.3±0.1 (0.091±0.004)	4.0±0.1 (0.157±0.004)	0.85 (0.033)	0.3 (0.012)

Unit: mm(inch)

Embossed Tape (4mm wide)



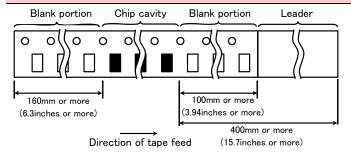
Unit: mm

	Olik Tillin						
T	Thickness	Chip cavity		Insertion Pitch	Insertion Pitch Tape Thickness		
Туре	mm(inch)	Α	В	F	K	Т	
HKQ0402(01005)	0.2 (0.008)	0.23	0.43	1.0±0.02	0.5max.	0.25max.	

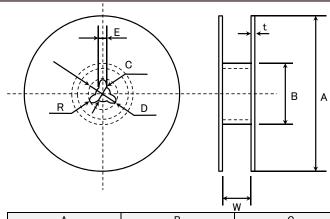
 $\mathsf{Unit}:\mathsf{mm}$

[►] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

4LEADER AND BLANK PORTION



⑤Reel Size



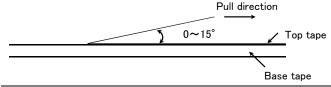
Α	В	С	D	E	R
ϕ 178 ± 2.0	ϕ 50 or more	ϕ 13.0 \pm 0.2	ϕ 21.0 ± 0.8	2.0±0.5	1.0

	t	W
4mm width tape	1.5max.	5±1.0
8mm width tape	2.5max.	10±1.5

(Unit : mm)

6Top tape strength

The top tape requires a peel-off force of 0.1 \sim 0.7N in the direction of the arrow as illustrated below.



This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

Multilayer chip inductors Multilayer chip inductors for high frequency, Multilayer chip bead inductors Multilayer common mode choke coils (MC series F type)

RELIABILITY DATA

1. Operating Temp	erature Range			
	BK0402			
	BK0603			
	BK1005			
	BKH0603			
	BKH1005			
	BK1608			
	BK2125			
	ARRAY	BK2010		
	ARRAY	BK3216		
	BKP0402	•		
	BKP0603			
	BKP1005			
	BKP1608			
	BKP2125			
	MCF 0605			
	MCF 0806		10 1070	
	MCF 1210		— −40~+85°C	
	MCF 2010			
0 'C 17/1	CK1608			
Specified Value	CK2125			
	CKS2125			
	CKP1608			
	CKP2012			
	CKP2016			
	CKP2520			
	NM2012			
	NM2520			
	LK1005			
	LK1608			
	LK2125			
	HK0402/HKQ	0402		
	HK0603			
	HK1005			
	HK1608		-40~+85°C	
	HK2125		—————————————————————————————————————	
	HKQ0603W/H	IKQ0603C/HKQ0603S/		
	HKQ0603U/			
	AQ105			

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

2. Storage Temper		
	BK0402	
	BK0603	
	BK1005	
	BKH0603	
	BKH1005	-55~+125°C
	BK1608	
	BK2125	
	ARRAY BK2010	
	BK3216	
	BKP0402	
	BKP0603	
	BKP1005	-55~+85°C
	BKP1608	
	BKP2125	
	MCF 0605	
	MCF 0806	40 1000
	MCF 1210	-40~+85°C
	MCF 2010	
Specified Value	CK1608	
Specified value	CK2125	
	CKS2125	
	CKP1608	
	CKP2012	
	CKP2016	-40~+85°C
	CKP2520	-40~+85 C
	NM2012	
	NM2520	
	LK1005	
	LK1608	
	LK2125	
	HK0402/HKQ0402	
	HK0603	_55~+125°C
	HK1005	
	HK1608	
	HK2125	-40~ +80 C
	HKQ0603W/HKQ0603C/HKQ0603	3\$/
	HKQ0603U/	-55~+125°C
	AQ105	

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

3. Rated Current			
3. Rated Gurrent	BK0402		150~750mA DC
	BK0603		100~500mA DC
	BK1005		120~1000mA DC
	BKH0603		115~160mA DC
	BKH1005		200~300mA DC
	BK1608		150~1500mA DC
	BK2125		200~1200mA DC
	BIVETED	BK2010	100mA DC
	ARRAY	BK3216	100~200mA DC
	BKP0402	BROZTO	1.1A DC
	BKP0603		0.8~1.8A DC
	BKP1005		0.8~2.4A DC
	BKP1608		1.0~3.0A DC
	BKP2125		1.5~4.0A DC
	MCF 0605		0.05A DC
	MCF 0806		0.1~0.13A DC
	MCF 1210		0.1~0.15A DC
	MCF 2010		0.1A DC
	CK1608		50~60mA DC
	CK2125		60~500mA DC
Specified Value	CKS2125		110~280mA DC
	CKP1608		0.35~0.9A DC
	CKP2012		0.7~1.2A DC
	CKP2016		0.9~1.6A DC
	CKP2520		1.1~1.8A DC
	NM2012		1.0~1.2A DC
	NM2520		0.9∼1.2A DC
	LK1005		20~25mA DC
	LK1608		1~150mA DC
	LK2125		5~300mA DC
	HK0402		160~380mA DC
	HK0603		60~470mA DC
	HK1005		110~300mA DC (-55~+125°C) 200~900mA DC (-55~+85°C)
	HK1608		150~300mA DC
	HK2125		300mA DC
	HKQ0402		100~500mA DC
	HKQ0603W		100~850mA DC
	HKQ0603C		160~850mA DC
	HKQ0603S		130~600mA DC

Definition of rated current:

HKQ0603U

AQ105

- •In the CK, CKS and BK Series, the rated current is the value of current at which the temperature of the element is increased within 20°C.
- •In the BK Series P type and CK Series P type, NM Series the rated current is the value of current at which the temperature of the element is increased within 40°C.

190~900mA DC

280~710mA DC

- •In the LK, HK, HKQ0603, and AQ Series, the rated current is either the DC value at which the internal L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20°C.
- •In the HKQ0402(~9N1), the rated current is either the DC value at which the internal L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20°C.
- •In the HKQ0402(10N~), the rated current is either the DC value at which the internal L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 25°C.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

4. Impedance		
	BK0402	$10\sim180\Omega$ ±5Ω(10Ω), ±25%(Other)
	BK0603	10~600Ω ±25%
	BK1005	10~1800Ω ±25%
	BKH0603	600~1500Ω ±25%
	BKH1005	600~1800Ω ±25%
	BK1608	22~2500Ω ±25%
	BK2125	15~2500Ω ±25%
	ARRAY BK2010	5~1000Ω ±25%
	BK3216	60~1000Ω ±25%
	BKP0402	10 ±5Ω
	BKP0603	$10\sim120\Omega$ $\pm5\Omega(10\Omega)$, $\pm25\%(Other)$
	BKP1005	$10\sim330$ Ω ±5Ω(EM100), ±25%(Other)
	BKP1608	33~470Ω ±25%
	BKP2125	33~330Ω ±25%
	MCF 0605	$12 \sim 90 \Omega \pm 5 \Omega (12 \Omega), \pm 20\% (35 \Omega), \pm 25\% (Other)$
	MCF 0806	$12 \sim 90 \Omega \pm 5 \Omega (12 \Omega), \pm 20\% (Other)$
	MCF 1210	$40 \sim 90 \Omega \pm 20\% (2H900), \pm 25\% (Other)$
	MCF 2010	90Ω ±25%
Specified Value	CK1608	
Specified value	CK2125	
	CKS2125	
	CKP1608	
	CKP2012	
	CKP2016	
	CKP2520	
	NM2012	
	NM2520	
	LK1005	
	LK1608	<u> </u>
	LK2125	
	HK0402/HKQ0402	
	HK0603	
	HK1005	
	HK1608	
	HK2125	
	HKQ0603W/HKQ0603C/HKQ06	038/
	HKQ0603U	
	AQ105	
	BK0402Series, BKP0402Series	
	Measuring frequency : 10	D±1MHz
	Measuring equipment : E4	991A(or its equivalent)
		197A(or its equivalent)
	BK0603Series, BKP0603Series	
	9	D±1MHz
	•	91A(or its equivalent)
		193A(or its equivalent)
	BK1005Series, BKP1005Series,	
Test Methods and		D±1MHz
Remarks		91A(or its equivalent)
		192A(or its equivalent), 16193A(or its equivalent)
	BK1608 • 2125Series, BKP1608 • 3	
	•	D±1MHz
		91A(or its equivalent), 4195A(or its equivalent)
		092A(or its equivalent) or 16192A(or its equivalent)/HW
	BK2010 · 3216Series, MCFSeries	
	J ,	D±1MHz
		91A(or its equivalent), 4195A(or its equivalent) 192A(or its equivalent)

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

5 Industance			
5. Inductance	BK0402		
	BK0603		1
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY BK2010		
	BK3216		_
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		4.7~10.0 μ H: ±20%
	CK2125		0.1~10.0 μ H: ±20%
	CKS2125		1.0~10.0 μ H: ±20%
Specified Value	CKP1608		0.33~2.2 μ H: ±20%
	CKP2012		0.47~4.7 μ H: ±20%
	CKP2016		0.47~4.7 μ H: ±20%
	CKP2520		0.47~4.7 μ H: ±20%
	NM2012		0.82~1.0 μ H: ±20%
	NM2520		1.0~2.2 μ H: ±20%
	LK1005		0.12~2.2 μ H: ±10 or 20%
	LK1608		$0.047 \sim 33.0 \mu\text{H}$: $\pm 20\%$ $0.10 \sim 12.0 \mu\text{H}$: $\pm 10\%$
	LK2125		$0.047 \sim 33.0 \mu\text{H}$: $\pm 20\%$ $0.10 \sim 12.0 \mu\text{H}$: $\pm 10\%$
	HK0402		1.0~5.6nH: ±0.3nH 6.8~12nH: ±5%
	HK0603		1.0~6.2nH: ±0.3nH 6.8~100nH: ±5%
	HK1005		1.0~6.2nH: ±0.3nH 6.8~270nH: ±5%
	HK1608		1.0~5.6nH: ±0.3nH 6.8~470nH: ±5%
	HK2125		1.5~5.6nH: ±0.3nH 6.8~470nH: ±5%
	HKQ0402		0.5~3.9nH: ±0.1 or 0.2 or 0.3nH 4.3~5.6nH: ±0.3nH or 3% or 5%
			6.2~47nH: ±3 or 5%
	HKQ0603W		0.6~3.9nH: ±0.1 or 0.2 or 0.3nH 4.3~6.2nH: ±0.2 or 0.3nH or 3 or 5%
	111/000000		6.8~27nH: ±3 or 5% 33~100nH: ±5%
	HKQ0603C		0.6~3.9nH: ±0.1 or 0.2 or 0.3nH 4.3~6.2nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5%
	HKQ0603S		0.6~6.2nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5%
	HKQ0603U		0.6~4.2nH: ±0.1 or 0.2 or 0.3nH 4.3~6.5nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5%
	AQ105		1.0~6.2nH: ±0.3nH 6.8~15nH: ±5%
	CK, LK, CKP, NM Series	. 0 = : 4NH - / O'	(1600)
	Measuring frequency	: 2~4MHz(CK	
	Measuring frequency Measuring frequency	: 2~25MHz(C : 2~10MHz(C	
	Measuring frequency	: 10~25MHz(I	
	Measuring frequency	: 1~50MHz(L	
	Measuring frequency	: 0.4~50MHz(
	Measuring frequency		608 • CKP2012 • CKP2016 • CKP2520 • NM2012 • NM2520)
	Measuring equipment /jig		85B+16092A(or its equivalent) •4195A+41951+16092A(or its equivalent)
			92A(or its equivalent) 4291A+16193A(or its equivalent)/LK1005
			341A+42842C+42851-61100(CKP1608·CKP2012·CKP2016·CKP2520·NM2012·NM2520)
Test Methods and	Measuring current	:•1mA rms(0.0	047~4.7 μ H)
Remarks		•0.1mA rms(5.6~33 μ H)
	HK, HKQ, AQ Series		
	Measuring frequency : 100MHz(HK0		402 · HK0603 · HK1005 · AQ105)
	Measuring frequency	: 50/100MHz(I	HK1608 • HK2125)
	Measuring frequency	: 500MHz(HKG	Q0603C·HKQ0603S·HKQ0603U)
	Measuring frequency	: 300/500MHz	
	Measuring frequency	: 100/500MHz	
	Measuring equipment /jig		97A(or its equivalent)/HK0603•AQ105
			93A(or its equivalent)/HK1005
			6197A (or its equivalent) /HKQ0603S •HKQ0603U •HKQ0603W •HKQ0603C
			192A + in-house made jig(or its equivalent)/HK1608+HK2125
	1	- E4331AT10	6196D(or its equivalent)/HK0402+HKQ0402

[►] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

6. Q			
	BK0402		
	BK0603		1
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
		BK2010	
	ARRAY	BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		
	CK2125		
Specified Value	CKS2125		
	CKP1608		
	CKP2012] –
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		10~20 min.
	LK1608		10∼35 min.
	LK2125		15∼50 min.
	HK0402		3 min.
	HK0603		4∼5 min.
	HK1005		8 min.
	HK1608		8~12 min.
	HK2125		10~18 min.
	HKQ0402 HKQ0603W		3~8 min. 6~15 min.
	HKQ0603W		14~15 min.
	HKQ0603C		10~13 min.
	HKQ0603U		14 min.
	AQ105		8 min.
	LKSeries		- C 11111.
	Measuring fre	quency : 10~25MHz(LK	(1005)
	Measuring fre		608)
	Measuring fre		
	Measuring equ	uipment /jig :•4194A+16085	
			+16092A(or its equivalent)
			A(or its equivalent)
	Masser		BA(or its equivalent)/LK1005
	Measuring cur	rent •1mA rms(0.04 •0.1mA rms(5.6	·
Test Methods and	HK, HKQ, AQ) - ου μ 11/
Remarks	Measuring fre		02 • HK0603 • HK1005 • AQ105)
	Measuring fre		
	Measuring fre		603C·HKQ0603S·HKQ0603U)
	Measuring fre		
	Measuring fre		
	Measuring equ		A(or its equivalent)/HK0603•AQ105
			BA(or its equivalent)/HK1005
			97A(or its equivalent)/HKQ0603S•HKQ0603U•HKQ0603W•HKQ0603C
			PA + in-house made jig(or its equivalent)/HK1608, HK2125
-		•E4991A + 1619	06D (or its equivalent) HK0402 • HKQ0402

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

	BK0402		0.07~0.75Ω max.
	BK0603		0.065~1.50Ω max.
	BK1005		0.03~0.90Ω max.
	BKH0603		1.50~3.20Ω max.
	BKH1005		0.85~2.00Ω max.
	BK1608		0.05~1.10Ω max.
	BK2125		0.05~0.75Ω max.
	ADDAY	BK2010	0.10~0.90 Ω max.
	ARRAY	BK3216	0.15~0.80 Ω max.
	BKP0402		0.07Ω max.
	BKP0603		0.030∼0.180Ω max.
	BKP1005		0.0273∼0.220Ω max.
	BKP1608		0.025~0.18Ω max.
	BKP2125		0.020 ~ 0.075 Ω max.
	MCF 0605		2.5∼6.5Ω max
	MCF 0806		2.5∼5.0Ω max.
	MCF 1210		2.5~4.5Ω max.
	MCF 2010		4.5 Ω max.
	CK1608		$0.45 \sim 0.85 \Omega \ (\pm 30\%)$
	CK2125		$0.16 \sim 0.65 \Omega$ max.
pecified Value	CKS2125		0.12~0.52 Ω max.
	CKP1608		0.15~0.35Ω max.
	CKP2012		0.08∼0.28 Ω max.
	CKP2016		0.075∼0.20Ω max
	CKP2520		0.05~0.16Ω max.
	NM2012		0.10∼0.15Ω max.
	NM2520		0.11∼0.22Ω max.
	LK1005		0.41∼1.16Ω max.
	LK1608		0.2~2.2Ω max.
	LK2125		0.1~1.1Ω max.
	HK0402		0.18~0.99Ω max.
	HK0603		0.11~3.74Ω max.
	HK1005		0.08~4.8Ω max.
	HK1608		0.05~2.6Ω max.
	HK2125		0.10~1.5Ω max.
	HKQ0402		0.08~5.0Ω max.
	HKQ0603W		0.07~4.1Ω max.
	HKQ0603C		0.07~1.6Ω max.
	HKQ0603S		0.06∼1.29Ω max.
	HKQ0603U		0.06∼1.29 Ω max.
	AQ105		0.07 ~ 0.45Ω max.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

0.0.15.0	(005)			
8. Self Resonance F				
	BK0402			
	BK0603 BK1005			
	BKH0603			
	BKH1005			
	BK1608			
	BK2125	DICOOLO		
	ARRAY	BK2010 BK3216		
	BKP0402	DN3Z10		
	BKP0603			
	BKP1005			
	BKP1608			
	BKP2125			
	MCF 0605			
	MCF 0806			
	MCF 1210			
	MCF 2010			47 000
	CK1608			17~25MHz min.
O 'C	CK2125			24~235MHz min.
Specified Value	CKS2125			24~75MHz min.
	CKP1608			
	CKP2012 CKP2016			
	CKP2016 CKP2520			-
	NM2012			
	NM2520			
	LK1005			40∼180MHz min.
	LK1608			9~260MHz min.
	LK2125			13~320MHz min.
	HK0402			2900~10000MHz min.
	HK0603			900~10000MHz min.
	HK1005			400~10000MHz min.
	HK1608			300∼10000MHz min.
	HK2125			200~4000MHz min.
	HKQ0402			1200~10000MHz min.
	HKQ0603W			800~10000MHz min.
	HKQ0603C			2500~10000MHz min.
	HKQ0603S			1900~10000MHz min.
	HKQ0603U			1900~10000MHz min.
	AQ105			2300~10000MHz min.
-	LK, CK Series :			2000 TOOODINIE IIIII.
	Measuring equi		: 4195A(or its ed	quivalent)
Test Methods and	= ::			A(or its equivalent)
Remarks	HK, HKQ, AQ Series :			
				quivalent) •8753D (or its equivalent) /HK2125

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

9. Temperature Cha	praeteristic		
a. Temperature Ona	BK0402		
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK11003		
	BK2125		
		BK2010	
	ARRAY	BK3216	
	BKP0402	BROZTO	
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		-
	MCF 1210		
	MCF 2010		
	CK1608		
	CK2125		
Specified Value	CKS2125		
opcomou value	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HK0402		
	HK0603		
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		Inductance change: Within ±10%
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
Test Methods and	HK、HKQ、AQ		
Remarks	Temperature		
- Ciliai No	Reference ter	mperature : +20°C	

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

10. Resistance to Flexure of Substrate BK0402 BK0603 BK1005 BKH0603 BKH1005 BK1608 BK2125 BK2010 ARRAY BK3216 BKP0402 BKP0603 BKP1005 BKP1608 BKP2125 MCF 0605 MCF 0806 MCF 1210 MCF 2010 CK1608 CK2125 Specified Value No mechanical damage. CKS2125 CKP1608 CKP2012 CKP2016 CKP2520 NM2012 NM2520 LK1005 LK1608 LK2125 HK0402 HK0603 HK1005 HK1608 HK2125 HKQ0402 HKQ0603W HKQ0603C HKQ0603S HKQ0603U AQ105 Warp : 2mm (BK Series without 0402size, BKP, BKH1005, CK, CKS, CKP, NM, LK, HK, HKQ0603S, HKQ0603U, AQ Series, MCF1210) : 1mm(BK0402, BKP0402, BKH0603, HK0402, HKQ0402, HKQ0603W, HKQ0603C Series, MCF Series without 1210 size.) Testing board : glass epoxy-resin substrate Thickness : 0.8mm Test Methods and Remarks Board Warp Deviation± 1/ 45 45 (Unit:mm)

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

11 Caldavahilitur			
11. Solderability	BK0402		
	BK0603		-
	BK1005		
	BKH0603		-
	BKH1005		-
	BK1608		-
	BK2125		-
	DKZ1Z3	BK2010	-
	ARRAY	BK3216	-
	BKP0402	BN3210	At least 75% of terminal electrode is covered by new solder.
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		-
	MCF 0605		-
	MCF 0805		-
	MCF 0800		-
	MCF 1210		-
	CK1608		
Constitut Value	CK2125		
	CKS2125		
Specified Value	CKP1608		
	CKP2012		
	CKP2016		-
	CKP2520		At least 75% of terminal electrode is covered by new solder.
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HK0402		The loads 1070 of command discussed is consisted by non-colucit.
	HK0603		
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		1
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		1
T . M . I . I	Solder tempera	ture :230±5°C (JIS Z	3282 H60A or H63A)
Test Methods and	Solder temperat		0Ag/0.5Cu)
Remarks	Duration	:4±1 sec.	

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

12. Resistance to S	oldering				
	BK0402				
	BK0603				
	BK1005				
	BKH0603				
	BKH1005				
	BK1608				
	BK2125			Appearance: No significant abnormality	
	ARRAY	BK2010		Impedance change:Within ±30%	
	70000	BK3216			
	BKP0402				
	BKP0603				
	BKP1005				
	BKP1608				
	BKP2125				
	MCF 0605				
	MCF 0806			Appearance: No significant abnormality	
	MCF 1210			Impedance change:Within ±20%	
	MCF 2010				
	CK1608			No machanical damage	
	CK2125			No mechanical damage. Remaining terminal electrode: 70% min	
	CKS2125			Normalining communications and a minimum of the control of the con	
	CKP1608			Inductance change	
Specified Value	CKP2012			R10~4R7: Within ±10% 6R8~100: Within ±15% CKS2125: Within ±20% CKP1608, CKP2012, CKP2016, CKP2520, NM2012, NM2520: Within ±30%	
•	CKP2016				
	CKP2520				
	NM2012				
	NM2520				
	LK1005			No mechanical damage.	
				Remaining terminal electrode: 70% min. Inductance change: Within ±15%	
	LK1608			No mechanical damage.	
	LK1006			Remaining terminal electrode: 70% min.	
	LK2125			Inductance change	
				47N~4R7: Within ±10%	
				5R6~330: Within ±15%	
	HK0402				
	HK0603				
	HK1005				
	HK1608				
	HK2125			No mechanical damage.	
	HKQ0402			Remaining terminal electrode: 70% min.	
	HKQ0603W			Inductance change: Within ±5%	
	HKQ0603C				
	HKQ0603S				
	HKQ0603U				
	AQ105				
	Solder tempera	iture	:260±5°C		
	Duration :10±0.5 sec.				
Test Methods and	Preheating temperature :150 to 180°C				
Remarks	Preheating time	Э	:3 min.		
	Flux :Immersion into			o methanol solution with colophony for 3 to 5 sec.	
	Recovery		:2 to 3 hrs of r	recovery under the standard condition after the test. (See Note 1)	

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

10 TI 101						
13. Thermal Shock	D1(0.400					
	BK0402					
	BK0603					
	BK1005					
	BKH0603		-			
	BKH1005		-			
	BK1608					
	BK2125	T DICOGLO	Appearance: No significant abnormality			
	ARRAY	BK2010	Impedance chang	e: Within ±30%		
	BK3216					
	BKP0402 BKP0603		-			
			-			
	BKP1005		-			
	BKP1608		-			
	BKP2125					
	MCF 0605			t terms to the		
	MCF 0806			significant abnormality		
	MCF 1210		Impedance chang	ge: Within ±20%		
	MCF 2010					
	CK1608		No mechanical damage.			
0 'C 1 / 1	CK2125		Inductance change: Within ±20% Q change: Within ±30%			
Specified Value	CKS2125		Inductance change: Within ±20% (CKS2125)			
	CKP1608		No mechanical damage. Inductance change: Within ±30%			
<u>-</u>	CKP2012					
	CKP2016					
	CKP2520					
	NM2012 NM2520		-			
	LK1005					
	LK1608		No mechanical damage. Inductance change: Within $\pm 10\%$ Q change: Within $\pm 30\%$			
	LK2125					
	HK0402					
	HK0603					
	HK1005					
	HK1608		-			
	HK2125					
	HKQ0402		No mechanical da	_		
	HKQ0603W		Inductance chang	ge: Within ±10% Q change: Within ±20%		
	HKQ0603C					
	HKQ0603S					
	HKQ0603U		-			
	AQ105					
	Conditions for	1 cycle	I.			
	Step	temperature (°C)		time (min.)		
	1	Minimum operating temperatu	re +0/-3	30±3		
Test Methods and	2	Room temperature		2~3		
Remarks	3	Maximum operating temperatu		30±3		
	4	Room temperature		2~3		
	Number of cyc					
	Danas (0 ±			5 J J J (C N J 1)		

Recovery: 2 to 3 hrs of recovery under the standard condition after the test. (See Note 1)

(Note 1) When there are questions concerning measurement result; measurement shall be made after 48±2 hrs of recovery under the standard condition.

[▶] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

14. Damp Heat (St	-					
	BK0402					
	BK0603					
	BK1005					
	BKH0603					
	BKH1005					
	BK1608					
	BK2125	T	Appearance: No significant abnormality			
	ARRAY	BK2010	Impedance change: Within ±30%			
		BK3216				
	BKP0402					
	BKP0603					
	BKP1005					
	BKP1608					
	BKP2125					
	MCF 0605		A N			
	MCF 0806 MCF 1210		Appearance: No significant abnormality			
			Impedance change: Within ±20%			
	MCF 2010 CK1608		Mk			
	CK1008		No mechanical damage. Inductance change: Within ±20% Q change: Within ±30%			
	CKS2125		Inductance change: Within ±20% & change: Within ±30%			
Specified Value	CKP1608		Inductance change. Within ±20%			
	CKP2012					
	CKP2016		No mechanical damage.			
	CKP2520		Inductance change: Within ±30%			
	NM2012					
	NM2520					
	LK1005		No mechanical damage.			
	LK1608		Inductance change: Within ±10% Q change: Within ±30%			
	1140405		No mechanical damage.			
	LK2125		Inductance change: Within ±20% Q change: Within ±30%			
	HK0402					
	HK0603					
	HK1005					
	HK1608		No mechanical damage.			
	HK2125					
	HKQ0402		Inductance change: Within ±10% Q change: Within ±20%			
	HKQ0603W		inductance ordings. Within 21076 & ordings. Within 22076			
	HKQ0603C					
	HKQ0603S					
	HKQ0603U					
	AQ105	0 1 1105 6 1				
		Series, MCF Series:				
	Temperature	: 40±2°C : 90 to 95%RH				
	Humidity Duration	:500+24/-0 hrs				
	Recovery		er the standard condition after the removal from test chamber.(See Note 1)			
Test Methods and	1 1000 VOI y	. 2 to o mis or recovery und	or and damaged domainon and removal from test offamour (ode Note 1)			
Remarks	LK, CK, CKS.	CKP、NM、HK、HKQ、AQ Seri	es:			
	Temperature	:40±2°C(LK, CK, CKS, C				
		:60±2°C(HK, HKQ, AQ S				
	Humidity	:90 to 95%RH				
	Duration	:500±12 hrs				
	Recovery	:2 to 3 hrs of recovery und	er the standard condition after the removal from test chamber.(See Note 1)			

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

15. Loading under D	amp Heat				
	BK0402				
	BK0603				
	BK1005				
	BKH0603				
	BKH1005				
	BK1608		-		
	BK2125		Annayana Na simificant shown lity		
			Appearance: No significant abnormality		
	I ARRAY -	K2010	Impedance change: Within ±30%		
		K3216	_		
	BKP0402				
	BKP0603				
	BKP1005				
	BKP1608				
	BKP2125				
	CK1608		No mechanical damage.		
	CK2125		Inductance change: Within ±20% Q change: Within ±30%		
	01/00105		No mechanical damage.		
	CKS2125		Inductance change: Within ±20%		
	CKP1608				
	CKP2012				
	CKP2016		No mechanical damage.		
Specified Value	CKP2520		Inductance change: Within ±30%		
	NM2012		Industration officings. Within 20070		
	NM2520				
	INIVIZUZO		No woodhowical dawage		
	LK1005		No mechanical damage.		
			Inductance change: Within ±10% Q change: Within ±30%		
	L K1600		No mechanical damage.		
	LK1608		Inductance change: $0.047 \sim 12.0 \mu$ H: Within $\pm 10\%$ $15.0 \sim 33.0 \mu$ H: Within $\pm 15\%$		
			Q change: Within ±30%		
	LK2125		No mechanical damage. Inductance change: Within ±20% Q change: Within ±30%		
	HK0402		Inductance change. Within ±2070 Q change. Within ±3070		
	HK0603		-		
	HK1005				
	HK1608				
	HK2125		No mechanical damage.		
	HKQ0402		Inductance change: Within ±10% Q change: Within ±20%		
	HKQ0603W				
	HKQ0603C				
	HKQ0603S				
	HKQ0603U				
	AQ105				
	BK、BKP、BKH Ser	ries:			
	Temperature	:40±2°C			
	Humidity	:90 to 95%RH			
	Applied current	:Rated current			
	Duration	:500+24/-0 hrs			
Took Matherda and	Recovery	:2 to 3 hrs of recovery	under the standard condition after the removal from test chamber. (See Note 1)		
Test Methods and	LK, CK, CKS, CKF	NK、HK、HKQ、AQ Seri	es:		
Remarks	Temperature	:40±2°C(LK, CK, CH	KS, CKP, NM Series)		
		:60±2°C(HK, HKQ,			
	Humidity	:90 to 95%RH			
	Applied current	:Rated current			
	Duration	:500±12 hrs			
	Recovery :2 to 3 hrs of recovery under the standard condition after the removal from test chamber. (See Note 1)				
	Recoverv	:2 to 3 hrs of recovery	under the standard condition after the removal from test chamber.(See Note 1)		

5 to $35^{\circ}\text{C}\,$ of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of $20\pm2^{\circ}C$ of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure.

Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

16. Loading at High	Temperature			
TO. LOGUING AT THE	BK0402			
	BK0603			
	BK1005			
	BKH0603			
	BKH1005			
	BK1608			
	BK2125	Appearance: No significant abnormality		
	ARRAY BK2010	Impedance change: Within ±30%		
	BK3216			
	BKP0402			
	BKP0603			
	BKP1005			
	BKP1608			
	BKP2125			
	MCF 0605			
	MCF 0806	Appearance: No significant abnormality		
	MCF 1210	Impedance change: Within ±20%		
	MCF 2010			
	CK1608	No mechanical damage.		
	CK2125	Inductance change: Within ±20% Q change: Within ±30%		
		No mechanical damage.		
	CKS2125	Inductance change: Within ±20%		
	CKP1608			
Specified Value	CKP2012			
	CKP2016	No mechanical damage.		
	CKP2520	Inductance change: Within ±30%		
	NM2012	and detailed sharige. Within 20079		
	NM2520			
	TVIVIZUZU	No mechanical damage.		
	LK1005	Inductance change: Within ±10% Q change: Within ±30%		
		No mechanical damage.		
	LK1608	Inductance change: $0.047 \sim 12.0 \mu$ H: Within $\pm 10\%$ $15.0 \sim 33.0 \mu$ H: Within $\pm 15\%$		
	EKTOOO	Q change: Within ±30%		
		No mechanical damage.		
	LK2125	Inductance change: Within ±20% Q change: Within ±30%		
	HK0402			
	HK0603			
	HK1005			
	HK1608			
	HK2125			
		No mechanical damage.		
	HKQ0402	Inductance change: Within ±10% Q change: Within ±20%		
	HKQ0603W			
	HKQ0603C			
	HKQ0603S			
	HKQ0603U			
	AQ105	DE Conica.		
	BK, BKH, BKP Series, N			
	Temperature : 125±3	C(BK, BKH Series)		
	: 85±3 Applied current : Rated			
	1 ''	urrent I/-0 hrs		
		rs of recovery under the standard condition after the removal from test chamber.		
	(See No	•		
Test Methods and	LK, CK, CKS, CKP, NM	•		
Remarks		rn, nnd, Ad Series. :(LK, CK, CKS, CKP, NM Series)		
	l .	(HK1608, 2125)		
		(KK1005, AQ105) C(HK1005, AQ105 operating temperature range $-55 \sim +85$ °C)		
		C(HK0402, HKQ0402, HK0603, HK1005, HKQ0603S, HKQ0603U, HKQ0603W, HKQ0603C, AQ105		
	: 125±2 C (HK0402, HK00402, HK00603, HK1005, HK00603S, HK00603U, HK00603W, HK00603C, AQ105 operating temperature range –55~ +125°C)			
	Applied current : Rated			
	Duration :500±1			
		rs of recovery under the standard condition after the test.(See Note 1)		
	,500	• " " " " " " " " " " " " " " " " " " "		

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to 35°C of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of $20\pm2^{\circ}C$ of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after 48±2 hrs of recovery under the standard condition.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

Precautions on the use of Multilayer chip inductors Multilayer chip inductors for high frequency, Multilayer chip bead inductors Multilayer common mode choke coils (MC series F type)

■PRECAUTIONS

1. Circuit Design

◆Verification of operating environment, electrical rating and performance

1. A malfunction in medical equipment, spacecraft, nuclear reactors, etc. may cause serious harm to human life or have severe social ramifications.

Precautions

As such, any inductors to be used in such equipment may require higher safety and/or reliability considerations and should be clearly differentiated from components used in general purpose applications.

- ◆Operating Current(Verification of Rated current)
 - 1. The operating current for inductors must always be lower than their rated values.
 - 2. Do not apply current in excess of the rated value because the inductance may be reduced due to the magnetic saturation effect.

2. PCB Design

Precautions

◆Pattern configurations(Design of Land-patterns)

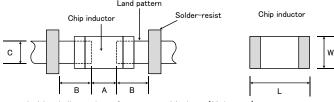
1. When inductors are mounted on a PCB, the size of land patterns and the amount of solder used (size of fillet) can directly affect inductor performance.

Therefore, the following items must be carefully considered in the design of solder land patterns:

- (1) The amount of solder applied can affect the ability of chips to withstand mechanical stresses which may lead to breaking or cracking. Therefore, when designing land-patterns it is necessary to consider the appropriate size and configuration of the solder pads which in turn determines the amount of solder necessary to form the fillets.
- (2) When more than one part is jointly soldered onto the same land or pad, the pad must be designed so that each component's soldering point is separated by solder-resist.
- (3) The larger size of land patterns and amount of solder, the smaller Q value after mounting on PCB. It makes higher the Q value to design land patterns smaller than terminal electrode of chips.
- ◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)
 - 1. After inductors have been mounted on the boards, chips can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering the reflow soldered boards etc.) For this reason, planning pattern configurations and the position of SMD inductors should be carefully performed to minimize stress

◆Pattern configurations (Design of Land-patterns)

- The following diagrams and tables show some examples of recommended patterns to prevent excessive solder amounts (larger fillets which extend above the component end terminations). Examples of improper pattern designs are also shown.
 - (1) Recommended land dimensions for a typical chip inductor land patterns for PCBs



Recommended land dimensions for wave-soldering (Unit:mm)

Туре		1608	2012	2125	2016	2520	3216
Size	L	1.6	2.0	2.0	2.0	2.5	3.2
Size	W	0.8	1.25	1.25	1.6	2.0	1.6
A	4	0.8~1.0	1.0~1.4	1.0~1.4	1.0~1.4	1.0~1.4	1.8~2.5
В		0.5~0.8	0.8~1.5	0.8~1.5	0.8~1.5	0.6~1.0	0.8~1.7
С		0.6~0.8	0.9~1.2	0.9~1.2	1.3~1.6	1.6~2.0	1.2~1.6

Technical considerations

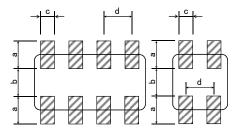
Recommended land dimensions for reflow-soldering (Unit:mm)

Ту	ре	0402	0603	1005	105	1608	2012
Size	L	0.4	0.6	1.0	1.0	1.6	2.0
Size	W	0.2	0.3	0.5	0.6	0.8	1.25
-	4	0.15~0.25	0.20~0.30	0.45~0.55	0.50~0.55	0.8~1.0	0.8~1.2
E	3	0.10~0.20	0.20~0.30	0.40~0.50	0.30~0.40	0.6~0.8	0.8~1.2
()	0.15~0.30	0.25~0.40	0.45~0.55	0.60~0.70	0.6~0.8	0.9~1.6

Type		2125	2016	2520	3216
Size	L	2.0	2.0	2.5	3.2
	W	1.25	1.6	2.0	1.6
Α		0.8~1.2	0.8~1.2	1.0~1.4	1.8~2.5
В		0.8~1.2	0.8~1.2	0.6~1.0	0.6~1.5
С		0.9~1.6	1.2~2.0	1.8~2.2	1.2~2.0

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

Excess solder can affect the ability of chips to withstand mechanical stresses. Therefore, please take proper precautions when designing land-patterns.



Recommended land dimension for Reflow-soldering

Type		3216	2010	1210	0806	0605
Size	L	3.2	2.0	1.25	0.85	0.65
Size	W	1.6	1.0	1.0	0.65	0.50
а		0.7~0.9	0.5~0.6	0.45~0.55	0.25~0.35	0.27~0.33
b		0.8~1.0	0.5~0.6	0.7~0.8	0.25~0.35	0.17~0.23
С		0.4~0.5	0.2~0.3	0.25~0.35	0.25~0.35	0.20~0.26
d		0.8	0.5	0.55	0.5	0.4

(Unit:mm)

((2) Examples of good and bad solder application

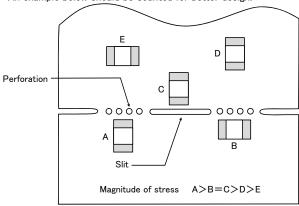
٦,	Examples of good and bad solder application					
	Item	Not recommended	Recommended			
	Mixed mounting of SMD and leaded components	Lead wire of component	Solder-resist			
	Component placement close to the chassis	Chassis Solder (for grounding) Electrode pattern	Solder-resist			
	Hand-soldering of leaded components near mounted components	Lead wire of component Soldering iron	Solder-resist			
	Horizontal component placement		Solder-resist			

- ◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)
 - 1-1. The following are examples of good and bad inductor layout; SMD inductors should be located to minimize any possible mechanical stresses from board warp or deflection.

Item	Not recommended	Recommended	
Deflection of the board		Position the component at a right angle to the direction of the mechanical stresses that are anticipated.	of

1-2. To layout the inductors for the breakaway PC board, it should be noted that the amount of mechanical stresses given will vary depending on inductor layout.

An example below should be counted for better design.



1-3. When breaking PC boards along their perforations, the amount of mechanical stress on the inductors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, any ideal SMD inductor layout must also consider the PCB splitting procedure.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

3. Considerations for automatic placement

- ◆Adjustment of mounting machine
 - 1. Excessive impact load should not be imposed on the inductors when mounting onto the PC boards.
 - 2. The maintenance and inspection of the mounter should be conducted periodically.

Precautions

◆ Selection of Adhesives

1. Mounting inductors with adhesives in preliminary assembly, before the soldering stage, may lead to degraded inductor characteristics unless the following factors are appropriately checked; the size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, it is imperative to consult the manufacturer of the adhesives on proper usage and amounts of adhesive to use.

◆Adjustment of mounting machine

- 1. If the lower limit of the pick-up nozzle is low, too much force may be imposed on the inductors, causing damage. To avoid this, the following points should be considered before lowering the pick-up nozzle:
 - The lower limit of the pick-up nozzle should be adjusted to the surface level of the PC board after correcting for deflection of the board.
 - (2) The pick-up pressure should be adjusted between 1 and 3N static loads.
 - (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins should be used under the PC board. The following diagrams show some typical examples of good pick-up nozzle placement:

Item	Improper method	Proper method	
Single-sided mounting	chipping or cracking	supporting pins or back-up pins	
Double-sided mounting	chipping or cracking	supporting pins or back-up pins	

Technical considerations

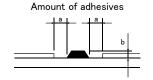
2. As the alignment pin wears out, adjustment of the nozzle height can cause chipping or cracking of the inductors because of mechanical impact on the inductors. To avoid this, the monitoring of the width between the alignment pin in the stopped position, and maintenance, inspection and replacement of the pin should be conducted periodically.

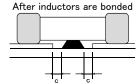
◆Selection of Adhesives

- 1. Some adhesives may cause reduced insulation resistance. The difference between the shrinkage percentage of the adhesive and that of the inductors may result in stresses on the inductors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect component placement, so the following precautions should be noted in the application of adhesives.
 - (1) Required adhesive characteristics
 - a. The adhesive should be strong enough to hold parts on the board during the mounting & solder process.
 - b. The adhesive should have sufficient strength at high temperatures.
 - c. The adhesive should have good coating and thickness consistency.
 - d. The adhesive should be used during its prescribed shelf life.
 - e. The adhesive should harden rapidly.
 - f. The adhesive must not be contaminated.
 - g. The adhesive should have excellent insulation characteristics.
 - h. The adhesive should not be toxic and have no emission of toxic gasses.
 - (2) When using adhesives to mount inductors on a PCB, inappropriate amounts of adhesive on the board may adversely affect component placement. Too little adhesive may cause the inductors to fall off the board during the solder process. Too much adhesive may cause defective soldering due excessive flow of adhesive on to the land or solder pad.

[Recommended conditions]

Figure	0805 case sizes as examples
а	0.3mm min
b	100∼120 μ m
С	Area with no adhesive





4. Soldering

Precautions

◆Selection of Flux

- 1. Since flux may have a significant effect on the performance of inductors, it is necessary to verify the following conditions prior to use;
 - (1) Flux used should be with less than or equal to 0.1 wt% (Chlorine conversion method) of halogenated content. Flux having a strong acidity content should not be applied.
 - (2) When soldering inductors on the board, the amount of flux applied should be controlled at the optimum level.
 - (3) When using water-soluble flux, special care should be taken to properly clean the boards.

◆ Soldering

1. Temperature, time, amount of solder, etc. are specified in accordance with the following recommended conditions, and please contact us about peak temperature when you use lead-free paste.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

◆Selection of Flux

- 1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate the flux, or highly acidic flux is used, an excessive amount of residue after soldering may lead to corrosion of the terminal electrodes or degradation of insulation resistance on the surface of the Inductor.
- 1-2. Flux is used to increase solderability in flow soldering, but if too much is applied, a large amount of flux gas may be emitted and may detrimentally affect solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.
- 1-3. Since the residue of water-soluble flux is easily dissolved by water content in the air, the residue on the surface of Inductor in high humidity conditions may cause a degradation of insulation resistance and therefore affect the reliability of the components. The cleaning methods and the capability of the machines used should also be considered carefully when selecting water-soluble flux.

◆Soldering

1-1. Preheating when soldering

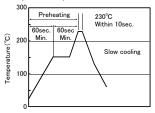
Heating: Chip inductor components should be preheated to within $100 \text{ to } 130^{\circ}\text{C}$ of the soldering. Cooling: The temperature difference between the components and cleaning process should not be greater than 100°C .

Chip inductors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling. Therefore, the soldering process must be conducted with a great care so as to prevent malfunction of the components due to excessive thermal shock

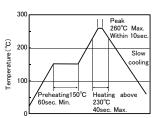
Recommended conditions for soldering

[Reflow soldering]

Temperature profile



Pb free soldering



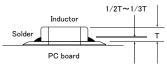
**Ceramic chip components should be preheated to within 100 to 130°C of the soldering.

*Assured to be reflow soldering for 2 times.

Caution

Technical considerations

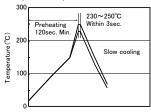
1. The ideal condition is to have solder mass (fillet) controlled to 1/2 to 1/3 of the thickness of the inductor, as shown below:

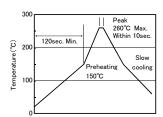


2. Because excessive dwell times can detrimentally affect solderability, soldering duration should be kept as close to recommended times as possible.

[Wave soldering]

Temperature profile





*Ceramic chip components should be preheated to within 100 to 130°C of the soldering.

*Assured to be wave soldering for 1 time.

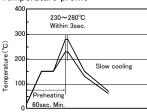
Except for reflow soldering type.

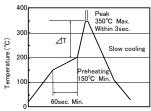
Caution

- 1. Make sure the inductors are preheated sufficiently.
- 2. The temperature difference between the inductor and melted solder should not be greater than 100 to 130° C.
- 3. Cooling after soldering should be as gradual as possible.
- 4. Wave soldering must not be applied to the inductors designated as for reflow soldering only.

[Hand soldering]

Temperature profile





($\Arrowvert \Delta T \le 190$ °C(3216Type max), $\Delta T \le 130$ °C(3225 Type min)

imesIt is recommended to use 20W soldering iron and the tip is 1 ϕ or less.

*The soldering iron should not directly touch the components.

XAssured to be soldering iron for 1 time

Note: The above profiles are the maximum allowable soldering condition, therefore these profiles are not always recommended.

Caution 1. Use a 20W soldering iron with a maximum tip diameter of 1.0 mm. 2. The soldering iron should not directly touch the inductor.

5. Cleaning

Precautions

Technical

considerations

♦Cleaning conditions

- 1. When cleaning the PC board after the Inductors are all mounted, select the appropriate cleaning solution according to the type of flux used and purpose of the cleaning (e.g. to remove soldering flux or other materials from the production process.)
- 2. Cleaning conditions should be determined after verifying, through a test run, that the cleaning process does not affect the inductor's characteristics.

◆Cleaning conditions

- 1. The use of inappropriate solutions can cause foreign substances such as flux residue to adhere to the inductor, resulting in a degradation of the inductor's electrical properties (especially insulation resistance).
- 2. Inappropriate cleaning conditions (insufficient or excessive cleaning) may detrimentally affect the performance of the inductors.

(1) Excessive cleaning

a. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of the PC board which may lead to the cracking of the inductor or the soldered portion, or decrease the terminal electrodes' strength. Thus the following conditions should be carefully checked;

Ultrasonic output Below 20W/2
Ultrasonic frequency Below 40kHz
Ultrasonic washing period 5 min. or less

6. Post cleaning processes

◆Application of resin coatings, moldings, etc. to the PCB and components.

Precautions

- 1. With some type of resins a decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the inductor's performance.
- 2. When a resin's hardening temperature is higher than the inductor's operating temperature, the stresses generated by the excess heat may lead to inductor damage or destruction.
- 3. Stress caused by a resin's temperature generated expansion and contraction may damage inductors.

The use of such resins, molding materials etc. is not recommended.

7. Handling

- ◆Breakaway PC boards (splitting along perforations)
 - 1. When splitting the PC board after mounting inductors and other components, care is required so as not to give any stresses of deflection or twisting to the board.
 - 2. Board separation should not be done manually, but by using the appropriate devices.
- ◆General handling precautions
 - 1. Always wear static control bands to protect against ESD.
 - $\ensuremath{\mathbf{2}}.$ Keep the inductors away from all magnets and magnetic objects.
- Precautions
- 3. Use non-magnetic tweezers when handling inductors.4. Any devices used with the inductors (soldering irons, measuring instruments) should be properly grounded.
- 5. Keep bare hands and metal products (i.e., metal desk) away from chip electrodes or conductive areas that lead to chip electrodes.
- 6. Keep inductors away from items that generate magnetic fields such as speakers or coils.
- ◆Mechanical considerations
 - 1. Be careful not to subject the inductors to excessive mechanical shocks.
 - (1) If inductors are dropped on the floor or a hard surface they should not be used.
 - (2) When handling the mounted boards, be careful that the mounted components do not come in contact with or bump against other boards or components.

8. Storage conditions

◆Storage

1. To maintain the solderability of terminal electrodes and to keep the packaging material in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible.

Precautions

Recommended conditions

Ambient temperature Below 40°C

Humidity Below 70% RH

The ambient temperature must be kept below 30°C. Even under ideal storage conditions inductor electrode solderability decreases as time passes, so inductors should be used within 6 months from the time of delivery.

*The packaging material should be kept where no chlorine or sulfur exists in the air.

◆Storage

Technical considerations

1. If the parts are stocked in a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. For this reason, components should be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the inductors.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).